

December 1992

CMOS 4 -Bit D-Type Registers

Features

- High Voltage Type (20V Rating)
- Three State Outputs
- Input Disabled Without Gating the Clock
- Gated Output Control Lines for Enabling or Disabling the Outputs
- Standardized Symmetrical Output Characteristics
- 100% Tested for Quiescent Current at 20V
- Maximum Input Current of 1 μ A at 18V Over Full Package Temperature Range; 100nA at 18V and +25°C
- Noise Margin (Over Full Package/Temperature Range)
 - 1V at VDD = 5V
 - 2V at VDD = 10V
 - 2.5V at VDD = 15V
- 5V, 10V and 15V Parametric Ratings
- Meets All Requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

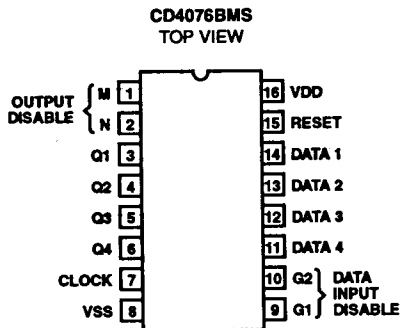
Description

CD4076BMS types are four-bit registers consisting of D-type flip-flops that feature three-state outputs. Data Disable inputs are provided to control the entry of data into the flip-flops. When both Data Disable inputs are low, data at the D inputs are loaded into their respective flip-flops on the next positive transition of the clock input. Output Disable inputs are also provided. When the Output Disable inputs are both low, the normal logic states of the four outputs are available to the load. The outputs are disabled independently of the clock by a high logic level at either Output Disable input, and present a high impedance.

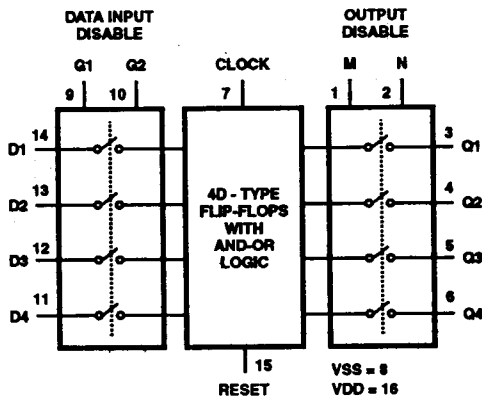
The CD4076BMS is supplied in these 16 lead outline packages:

| | |
|------------------|-----|
| Braze Seal DIP | H4T |
| Frit Seal DIP | H1E |
| Ceramic Flatpack | H6W |

Pinout



Functional Diagram



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LOGIC

Specifications CD4076BMS

Absolute Maximum Ratings

DC Supply Voltage Range, (VDD) -0.5V to +20V
 (Voltage Referenced to VSS Terminals)
 Input Voltage Range, All Inputs -0.5V to VDD +0.5V
 DC Input Current, Any One Input ±10mA
 Operating Temperature Range -55°C to +125°C
 Package Types D, F, K, H
 Storage Temperature Range (TSTG) -65°C to +150°C
 Lead Temperature (During Soldering) +265°C
 At Distance 1/16 ± 1/32 Inch (1.59mm ± 0.79mm) from case for
 10s Maximum

Reliability Information

Thermal Resistance θ_{JA} θ_{JC}
 Ceramic DIP and FRIT Package 80°C/W 20°C/W
 Flatpack Package 70°C/W 20°C/W
 Maximum Package Power Dissipation (PD) at +125°C
 For TA = -55°C to +100°C (Package Type D, F, K) 500mW
 For TA = +100°C to +125°C (Package Type D, F, K) Derate
 Linearity at 12mW/°C to 200mW
 Device Dissipation per Output Transistor 100mW
 For TA = Full Package Temperature Range (All Package Types)
 Junction Temperature +175°C

TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITIONS (NOTE 1) | | GROUP A SUBGROUP S | TEMPERATURE | LIMITS | | UNIT S |
|-----------------------------|--------|------------------------------------|-----------|--------------------------|----------------------|----------------|----------------|-----------|
| | | | | | | MIN | MAX | |
| Supply Current | IDD | VDD = 20V, VIN = VDD or GND | | 1 | +25°C | - | 10 | μA |
| | | | | 2 | +125°C | - | 1000 | μA |
| | | VDD = 18V, VIN = VDD or GND | | 3 | -55°C | - | 10 | μA |
| Input Leakage Current | IIL | VIN = VDD or GND | VDD = 20 | 1 | +25°C | -100 | - | nA |
| | | | | 2 | +125°C | -1000 | - | nA |
| | | | VDD = 18V | 3 | -55°C | -100 | - | nA |
| Input Leakage Current | IIH | VIN = VDD or GND | VDD = 20 | 1 | +25°C | - | 100 | nA |
| | | | | 2 | +125°C | - | 1000 | nA |
| | | | VDD = 18V | 3 | -55°C | - | 100 | nA |
| Output Voltage | VOL15 | VDD = 15V, No Load | | 1, 2, 3 | +25°C, +125°C, -55°C | - | 50 | mV |
| Output Voltage | VOH15 | VDD = 15V, No Load (Note 3) | | 1, 2, 3 | +25°C, +125°C, -55°C | 14.95 | - | V |
| Output Current (Sink) | IOL5 | VDD = 5V, VOUT = 0.4V | | 1 | +25°C | 0.53 | - | mA |
| Output Current (Sink) | IOL10 | VDD = 10V, VOUT = 0.5V | | 1 | +25°C | 1.4 | - | mA |
| Output Current (Sink) | IOL15 | VDD = 15V, VOUT = 1.5V | | 1 | +25°C | 3.5 | - | mA |
| Output Current (Source) | IOH5A | VDD = 5V, VOUT = 4.6V | | 1 | +25°C | - | -0.53 | mA |
| Output Current (Source) | IOH5B | VDD = 5V, VOUT = 2.5V | | 1 | +25°C | - | -1.8 | mA |
| Output Current (Source) | IOH10 | VDD = 10V, VOUT = 9.5V | | 1 | +25°C | - | -1.4 | mA |
| Output Current (Source) | IOH15 | VDD = 15V, VOUT = 13.5V | | 1 | +25°C | - | -3.5 | mA |
| N Threshold Voltage | VNTH | VDD = 10V, ISS = -10μA | | 1 | +25°C | -2.8 | -0.7 | V |
| P Threshold Voltage | VPTH | VSS = 0V, IDD = 10μA | | 1 | +25°C | 0.7 | 2.8 | V |
| Functional | F | VDD = 2.8V, VIN = VDD or GND | | 7 | +25°C | VOH > VDD/2 | VOL < VDD/2 | V |
| | | VDD = 20V, VIN = VDD or GND | | 7 | +25°C | | | |
| | | VDD = 18V, VIN = VDD or GND | | 8A | +125°C | | | |
| | | VDD = 3V, VIN = VDD or GND | | 8B | -55°C | | | |
| Input Voltage Low (Note 2) | VIL | VDD = 5V, VOH > 4.5V, VOL < 0.5V | | 1, 2, 3 | +25°C, +125°C, -55°C | - | 1.5 | V |
| Input Voltage High (Note 2) | VIH | VDD = 5V, VOH > 4.5V, VOL < 0.5V | | 1, 2, 3 | +25°C, +125°C, -55°C | 3.5 | - | V |
| Input Voltage Low (Note 2) | VIL | VDD = 15V, VOH > 13.5V, VOL < 1.5V | | 1, 2, 3 | +25°C, +125°C, -55°C | - | 4 | V |
| Input Voltage High (Note 2) | VIH | VDD = 15V, VOH > 13.5V, VOL < 1.5V | | 1, 2, 3 | +25°C, +125°C, -55°C | 11 | - | V |
| Tri-State Output Leakage | IOZL | VIN = VDD or GND VOUT = 0V | VDD = 20V | 1 | +25°C | -0.4 | - | μA |
| | | | | 2 | +125°C | -12 | - | μA |
| | | | VDD = 18V | 3 | -55°C | -0.4 | - | μA |

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TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITIONS (NOTE 1) | | GROUP A SUBGROUP S | TEMPERATURE | LIMITS | | UNIT S |
|-----------------------------|--------|--------------------------------|-----------|--------------------------|-------------|--------|-----|-----------|
| | | | | | | MIN | MAX | |
| Tri-State Output Leakage | IOZH | VIN = VDD or GND VOUT = VDD | VDD = 20V | 1 | +25°C | - | 0.4 | μA |
| | | | | 2 | +125°C | - | 12 | μA |
| | | | | 3 | -55°C | - | 0.4 | μA |

- NOTES: 1. All voltages referenced to device GND, 100% testing being implemented. 2. Go/No Go test with limits applied to inputs. 3. For accuracy, voltage is measured differentially to VDD. Limit is 0.050V max.

TABLE 2. AC ELECTRICAL PERFORMANCE CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITIONS (Notes 1, 2) | | GROUP A SUBGROUPS | TEMPERATURE | LIMITS | | UNITS |
|--|--------------|----------------------------|--|----------------------|---------------|--------|-----|-------|
| | | | | | | MIN | MAX | |
| Propagation Delay Clock to Q Output | TPHL TPLH | VDD = 5V, VIN = VDD or GND | | 9 | +25°C | - | 600 | ns |
| | | | | 10, 11 | +125°C, -55°C | - | 810 | ns |
| Transition Time | TTHL TTLH | VDD = 5V, VIN = VDD or GND | | 9 | +25°C | - | 200 | ns |
| | | | | 10, 11 | +125°C, -55°C | - | 270 | ns |

NOTES:

- CL = 50pF, RL = 200K, Input TR, TF < 20ns.
- 55°C and +125°C limits guaranteed, 100% testing being implemented.

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITIONS | NOTES | TEMPERATURE | LIMITS | | UNITS |
|-------------------------|--------|-----------------------------|-------|----------------------|--------|-------|-------|
| | | | | | MIN | MAX | |
| Supply Current | IDD | VDD = 5V, VIN = VDD or GND | 1, 2 | -55°C, +25°C | - | 5 | μA |
| | | | | +125°C | - | 150 | μA |
| | | VDD = 10V, VIN = VDD or GND | 1, 2 | -55°C, +25°C | - | 10 | μA |
| | | | | +125°C | - | 300 | μA |
| | | VDD = 15V, VIN = VDD or GND | 1, 2 | -55°C, +25°C | - | 10 | μA |
| | | | | +125°C | - | 600 | μA |
| Output Voltage | VOL | VDD = 5V, No Load | 1, 2 | +25°C, +125°C, -55°C | - | 50 | mV |
| Output Voltage | VOL | VDD = 10V, No Load | 1, 2 | +25°C, +125°C, -55°C | - | 50 | mV |
| Output Voltage | VOH | VDD = 5V, No Load | 1, 2 | +25°C, +125°C, -55°C | 4.95 | - | V |
| Output Voltage | VOH | VDD = 10V, No Load | 1, 2 | +25°C, +125°C, -55°C | 9.95 | - | V |
| Output Current (Sink) | IOL5 | VDD = 5V, VOUT = 0.4V | 1, 2 | +125°C | 0.36 | - | mA |
| | | | | -55°C | 0.64 | - | mA |
| Output Current (Sink) | IOL10 | VDD = 10V, VOUT = 0.5V | 1, 2 | +125°C | 0.9 | - | mA |
| | | | | -55°C | 1.6 | - | mA |
| Output Current (Sink) | IOL15 | VDD = 15V, VOUT = 1.5V | 1, 2 | +125°C | 2.4 | - | mA |
| | | | | -55°C | 4.2 | - | mA |
| Output Current (Source) | IOH5A | VDD = 5V, VOUT = 4.6V | 1, 2 | +125°C | - | -0.36 | mA |
| | | | | -55°C | - | -0.64 | mA |
| Output Current (Source) | IOH5B | VDD = 5V, VOUT = 2.5V | 1, 2 | +125°C | - | -1.15 | mA |
| | | | | -55°C | - | -2.0 | mA |

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TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)

| PARAMETER | SYMBOL | CONDITIONS | NOTES | TEMPERATURE | LIMITS | | UNITS |
|---|----------------|-------------------------------|------------|----------------------|--------|------|-------|
| | | | | | MIN | MAX | |
| Output Current (Source) | IOH10 | VDD = 10V, VOUT = 9.5V | 1, 2 | +125°C | - | -0.9 | mA |
| | | | | -55°C | - | -2.6 | mA |
| Output Current (Source) | IOH15 | VDD = 15V, VOUT = 13.5V | 1, 2 | +125°C | - | -2.4 | mA |
| | | | | -55°C | - | -4.2 | mA |
| Input Voltage Low | VIL | VDD = 10V, VOH > 9V, VOL < 1V | 1, 2 | +25°C, +125°C, -55°C | - | 3 | V |
| Input Voltage High | VIH | VDD = 10V, VOH > 9V, VOL < 1V | 1, 2 | +25°C, +125°C, -55°C | 7 | - | V |
| Propagation Delay Clock to Q Output | TPHL1 TPLH1 | VDD = 10V | 1, 2, 3 | +25°C | - | 250 | ns |
| | | VDD = 15V | 1, 2, 3 | +25°C | - | 180 | ns |
| Propagation Delay Reset | TPHL2 | VDD = 5V | 1, 2, 3 | +25°C | - | 460 | ns |
| | | VDD = 10V | 1, 2, 3 | +25°C | - | 200 | ns |
| | | VDD = 15V | 1, 2, 3 | +25°C | - | 150 | ns |
| Propagation Delay 3 - State | TPHZ TPLZ | VDD = 5V | 1, 2, 4 | +25°C | - | 300 | ns |
| | | VDD = 10V | 1, 2, 4 | +25°C | - | 150 | ns |
| | | VDD = 15V | 1, 2, 4 | +25°C | - | 120 | ns |
| Propagation Delay 3 - State | TPZH TPZL | VDD = 5V | 1, 2, 4 | +25°C | - | 300 | ns |
| | | VDD = 10V | 1, 2, 4 | +25°C | - | 150 | ns |
| | | VDD = 15V | 1, 2, 4 | +25°C | - | 120 | ns |
| Transition Time | TTHL TTLH | VDD = 10V | 1, 2, 3 | +25°C | - | 100 | ns |
| | | VDD = 15V | 1, 2, 3 | +25°C | - | 80 | ns |
| Transition Time | TTLH | VDD = 10V | 1, 2, 3 | +25°C | - | - | ns |
| | | VDD = 15V | 1, 2, 3 | +25°C | - | - | ns |
| Maximum Clock Input Frequency | FCL | VDD = 5V | 1, 2, 3 | +25°C | 3 | - | MHz |
| | | VDD = 10V | 1, 2, 3 | +25°C | 6 | - | MHz |
| | | VDD = 15V | 1, 2, 3 | +25°C | 8 | - | MHz |
| Minimum Data Setup Time | TS | VDD = 5V | 1, 2, 3 | +25°C | - | 200 | ns |
| | | VDD = 10V | 1, 2, 3 | +25°C | - | 80 | ns |
| | | VDD = 15V | 1, 2, 3 | +25°C | - | 60 | ns |
| Minimum Data Hold Time Reset Pulse Width | TW | VDD = 5V | 1, 2, 3 | +25°C | - | 120 | ns |
| | | VDD = 10V | 1, 2, 3 | +25°C | - | 50 | ns |
| | | VDD = 15V | 1, 2, 3 | +25°C | - | 40 | ns |
| Minimum Clock Pulse Width | TW | VDD = 5V | 1, 2, 3 | +25°C | - | 200 | ns |
| | | VDD = 10V | 1, 2, 3 | +25°C | - | 100 | ns |
| | | VDD = 15V | 1, 2, 3 | +25°C | - | 80 | ns |
| Minimum Data Input Set- Up Time | TS | VDD = 5V | 1, 2, 3 | +25°C | - | 180 | ns |
| | | VDD = 10V | 1, 2, 3 | +25°C | - | 100 | ns |
| | | VDD = 15V | 1, 2, 3 | +25°C | - | 70 | ns |
| Maximum Clock Input Rise and Fall Time | TRCL TFCL | VDD = 5V | 1, 2, 3, 5 | +25°C | - | 15 | µs |
| | | VDD = 10V | 1, 2, 3, 5 | +25°C | - | 5 | µs |
| | | VDD = 15V | 1, 2, 3, 5 | +25°C | - | 5 | µs |

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TABLE 6. APPLICABLE SUBGROUPS

| CONFORMANCE GROUP | MIL-STD-883 METHOD | GROUP A SUBGROUPS | READ AND RECORD |
|-------------------|--------------------|--------------------|-------------------|
| Group D | Sample 5005 | 1, 2, 3, 8A, 8B, 9 | Subgroups 1, 2, 3 |

NOTE: 1. 5% Parametric, 3% Functional; Cumulative for Static 1 and 2.

TABLE 7. TOTAL DOSE IRRADIATION

| CONFORMANCE GROUPS | MIL-STD-883 METHOD | TEST | | READ AND RECORD | |
|--------------------|--------------------|-----------|------------|-----------------|------------|
| | | PRE-IRRAD | POST-IRRAD | PRE-IRRAD | POST-IRRAD |
| Group E Subgroup 2 | 5005 | 1, 7, 9 | Table 4 | 1, 9 | Table 4 |

TABLE 8. BURN-IN AND IRRADIATION TEST CONNECTIONS

| FUNCTION | OPEN | GROUND | VDD | 9V ± 0.5V | OSCILLATOR | |
|-------------------------|-------|------------------|-----------------|-----------|------------|---------|
| | | | | | 50kHz | 25kHz |
| Static Burn-In 1 Note 1 | 3 - 6 | 1, 2, 7 - 15 | 16 | | | |
| Static Burn-In 2 Note 1 | 3 - 6 | 8 | 1, 2, 7, 9 - 16 | | | |
| Dynamic Burn-In Note 1 | - | 1, 2, 8 - 10, 15 | 16 | 3 - 6 | 7 | 11 - 14 |
| Irradiation (Note 2) | 3 - 6 | 8 | 1, 2, 7, 9 - 16 | | | |

NOTE:

1. Each pin except VDD and GND will have a series resistor of $10K \pm 5\%$, $VDD = 18V \pm 0.5V$
2. Each pin except VDD and GND will have a series resistor of $47K \pm 5\%$; Group E, Subgroup 2, sample size is 4 dice/wafer, 0 failures, $VDD = 10V \pm 0.5V$

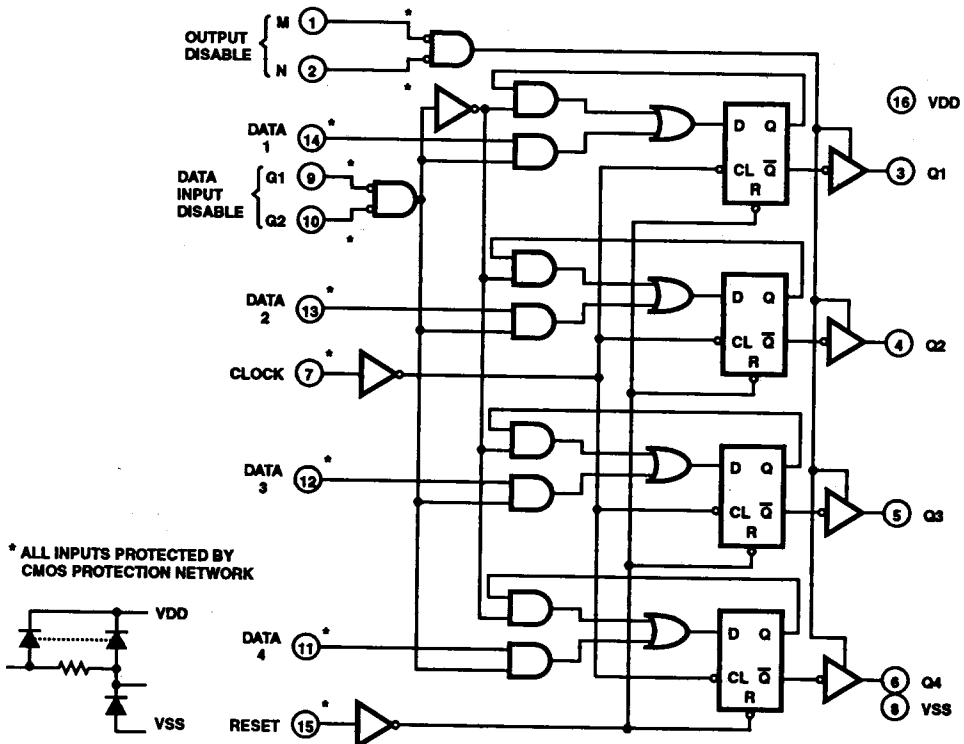


FIGURE 1. CD4076BMS LOGIC DIAGRAM

TRUTH TABLE

| RESET | CLOCK | DATA INPUT DISABLE | | DATA D | NEXT STATE OUTPUT Q | |
|-------|-------|--------------------|----|-----------|---------------------------|----|
| | | G1 | G2 | | | |
| 1 | X | X | X | X | 0 | |
| 0 | 0 | X | X | X | Q | NC |
| 0 | | 1 | X | X | Q | NC |
| 0 | | X | 1 | X | Q | NC |
| 0 | | 0 | 0 | 1 | 1 | |
| 0 | | 0 | 0 | 0 | 0 | |
| 0 | 1 | X | X | X | Q | NC |
| 0 | | X | X | X | Q | NC |

When either Output Disable M or N is high, the outputs are disabled (high impedance state), however sequential operation of the flip-flops is not affected

1 = High Level

0 = Low Level

X = Don't Care

NC = No Change

Typical Performance Characteristics

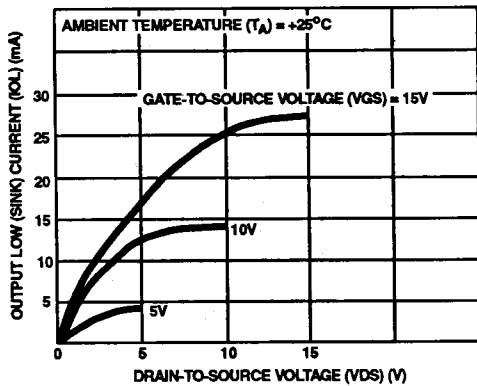


FIGURE 2. TYPICAL OUTPUT LOW (SINK) CURRENT CHARACTERISTICS

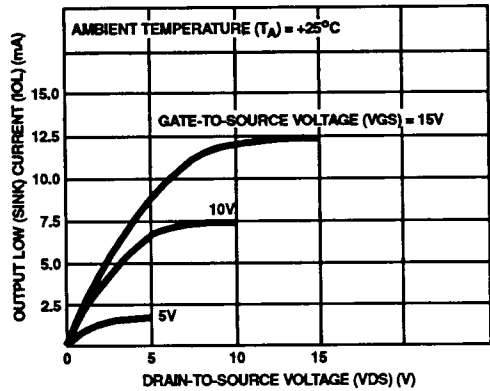


FIGURE 3. MINIMUM OUTPUT LOW (SINK) CURRENT CHARACTERISTICS

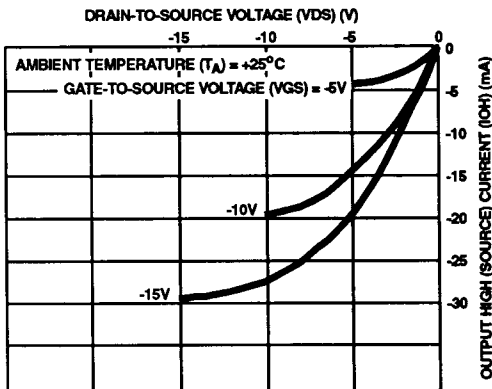


FIGURE 4. TYPICAL OUTPUT HIGH (SOURCE) CURRENT CHARACTERISTICS

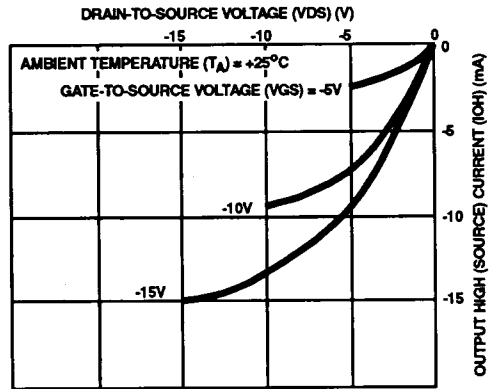


FIGURE 5. MINIMUM OUTPUT HIGH (SOURCE) CURRENT CHARACTERISTICS

Typical Performance Characteristics (Continued)

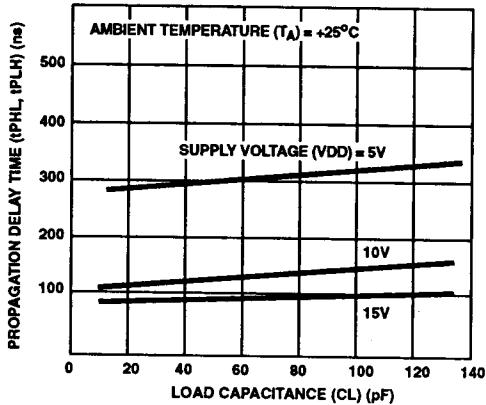


FIGURE 6. TYPICAL PROPAGATION DELAY TIME vs LOAD CAPACITANCE (CLOCK TO Q)

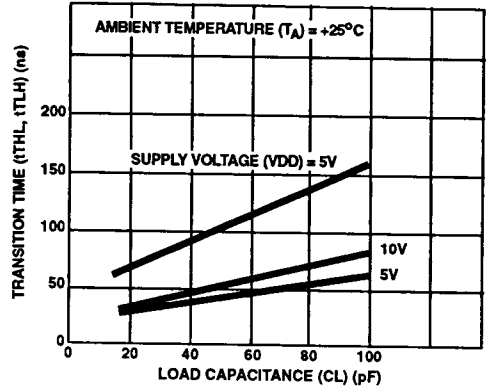


FIGURE 7. TYPICAL TRANSITION TIME vs LOAD CAPACITANCE

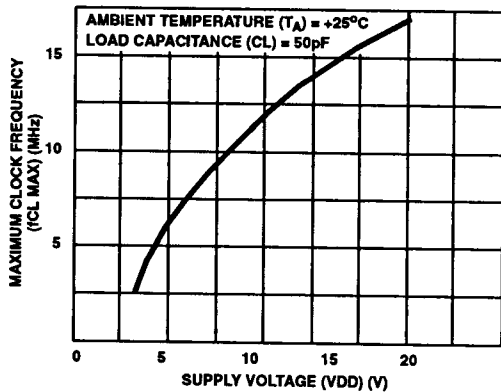


FIGURE 8. TYPICAL MAXIMUM CLOCK INPUT FREQUENCY vs SUPPLY VOLTAGE

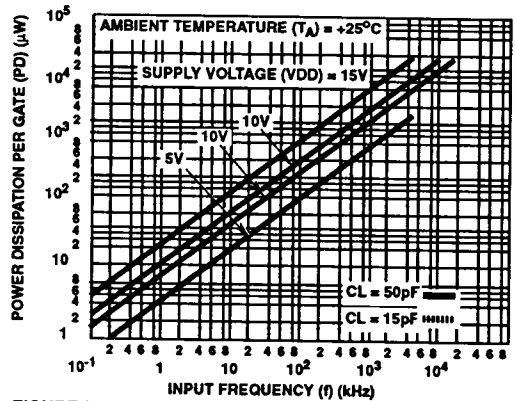


FIGURE 9. TYPICAL DYNAMIC POWER DISSIPATION vs FREQUENCY

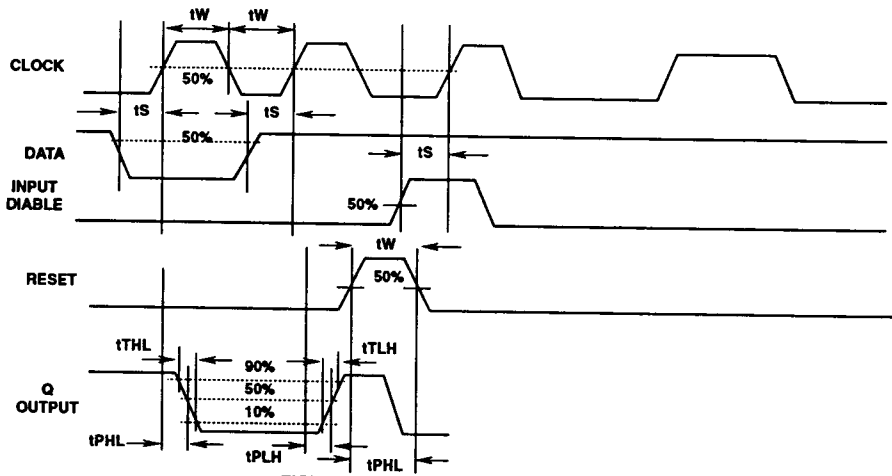
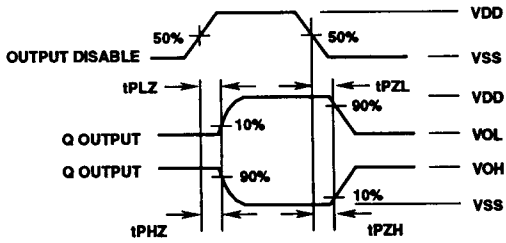


FIGURE 10. FUNCTIONAL WAVEFORM

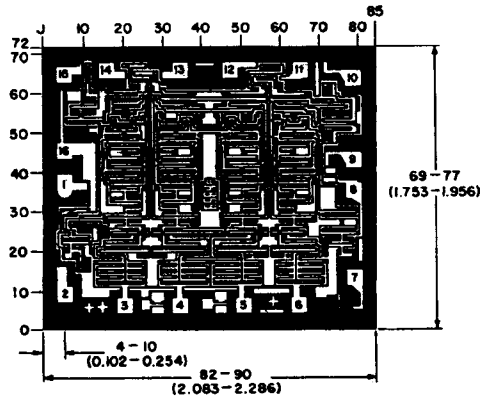
CD4076BMS



| CHARACTER | TEST | VOLTAGE |
|-----------|------|---------|
| | AT D | AT Q |
| tPHZ | VDD | VSS |
| tPLZ | VSS | VDD |
| tPZL | VSS | VDD |
| tPZH | VDD | VSS |

FIGURE 11. FUNCTIONAL WAVEFORM

Chip Dimensions and Pad Layout



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch)

METALLIZATION: Thickness: $11\text{k}\text{\AA} - 14\text{k}\text{\AA}$, AL

PASSIVATION: $10.4\text{k}\text{\AA} - 15.6\text{k}\text{\AA}$, Silane

BOND PADS: 0.004 inches X 0.004 inches MIN

DIE THICKNESS: 0.0198 inches - 0.0218 inches